

Final datasheet

EasyPACK™ 2B module and NTC

Features

- Electrical features
 - $V_{CES} = 650\text{ V}$
 - $I_{C\text{ nom}} = 100\text{ A} / I_{CRM} = 200\text{ A}$
 - Trench IGBT 5
 - Low switching losses
 - Suitable Infineon gate drivers can be found under <https://www.infineon.com/gdfinder>
- Mechanical features
 - Al_2O_3 substrate with low thermal resistance
 - Compact design
 - Solder contact technology
 - Rugged mounting due to integrated mounting clamps



Typical appearance

Potential applications

- Three-level applications
- Solar applications
- UPS systems

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

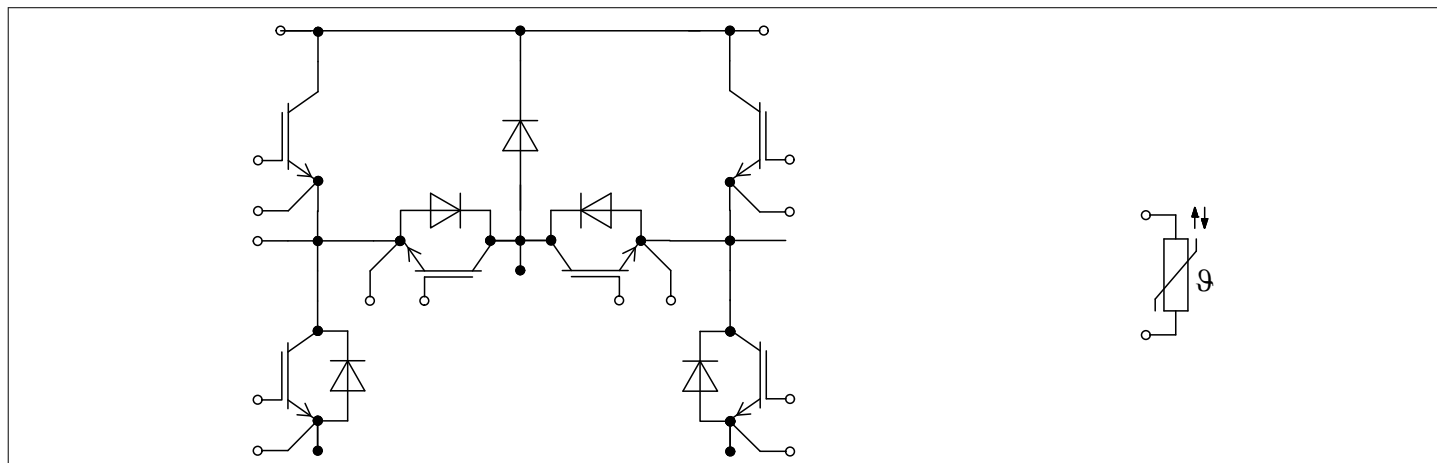


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1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	2.5	kV
Isolation test voltage NTC	$V_{ISOL(NTC)}$	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	2.5	kV
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Comparative tracking index	CTI		> 200	
Relative thermal index (electrical)	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{SCE}			17		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T = 25 \text{ °C}$, per switch		2.6		mΩ
Storage temperature	T_{stg}		-40		125	°C
Mounting force per clamp	F		40		80	N
Weight	G			39		g

Note: The current under continuous operation is limited to 30A rms per connector pin

2 IGBT, T1 / T3

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		$T_{vj} = 25 \text{ °C}$	650	V
Implemented collector current	I_{CN}			100	A
Continuous DC collector current	I_{CDC}	$T_{vj \text{ max}} = 175 \text{ °C}$	$T_H = 65 \text{ °C}$	80	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj \text{ op}}$		200	A
Gate-emitter peak voltage	V_{GES}			±20	V

Table 4 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 100\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$		1.42	1.90	V
			$T_{vj} = 125\ ^\circ C$		1.53		
			$T_{vj} = 150\ ^\circ C$		1.56		
Gate threshold voltage	V_{GETh}	$I_C = 1\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$		3.25	4.00	4.75	V
Gate charge	Q_G	$V_{GE} = \pm 15\ V, V_{CC} = 400\ V, T_{vj} = 25\ ^\circ C$			0.42		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\ ^\circ C$			0		Ω
Input capacitance	C_{ies}	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			7.13		nF
Reverse transfer capacitance	C_{res}	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			0.025		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 650\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$			11	μA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$				100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 100\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Gon} = 1\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.028		μs
			$T_{vj} = 125\ ^\circ C$		0.028		
			$T_{vj} = 150\ ^\circ C$		0.028		
Rise time (inductive load)	t_r	$I_C = 100\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Gon} = 1\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.017		μs
			$T_{vj} = 125\ ^\circ C$		0.021		
			$T_{vj} = 150\ ^\circ C$		0.021		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 100\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Goff} = 1\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.070		μs
			$T_{vj} = 125\ ^\circ C$		0.090		
			$T_{vj} = 150\ ^\circ C$		0.092		
Fall time (inductive load)	t_f	$I_C = 100\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Goff} = 1\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.036		μs
			$T_{vj} = 125\ ^\circ C$		0.050		
			$T_{vj} = 150\ ^\circ C$		0.056		
Turn-on energy loss per pulse	E_{on}	$I_C = 100\ A, V_{CC} = 300\ V, L_\sigma = 23\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 1\ \Omega, di/dt = 4300\ A/\mu s (T_{vj} = 150\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		0.24		mJ
			$T_{vj} = 125\ ^\circ C$		0.39		
			$T_{vj} = 150\ ^\circ C$		0.44		
Turn-off energy loss per pulse	E_{off}	$I_C = 100\ A, V_{CC} = 300\ V, L_\sigma = 23\ nH, V_{GE} = \pm 15\ V, R_{Goff} = 1\ \Omega, dv/dt = 6980\ V/\mu s (T_{vj} = 150\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		1.1		mJ
			$T_{vj} = 125\ ^\circ C$		1.58		
			$T_{vj} = 150\ ^\circ C$		1.74		
Thermal resistance, junction to heat sink	R_{thJH}	per IGBT, $\lambda_{grease} = 5\ W/(m \cdot K)$			0.71		K/W

(table continues...)

Table 4 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Temperature under switching conditions	$T_{vj\,op}$		-40		150	°C

3 IGBT, T2 / T4

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		$T_{vj} = 25\,^{\circ}\text{C}$	650	V
Implemented collector current	I_{CN}			100	A
Continuous DC collector current	I_{CDC}	$T_{vj\,max} = 175\,^{\circ}\text{C}$	$T_H = 65\,^{\circ}\text{C}$	70	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj\,op}$		200	A
Gate-emitter peak voltage	V_{GES}			± 20	V

Table 6 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\,sat}$	$I_C = 100\,\text{A}$, $V_{GE} = 15\,\text{V}$	$T_{vj} = 25\,^{\circ}\text{C}$		1.42	1.90	V
			$T_{vj} = 125\,^{\circ}\text{C}$		1.53		
			$T_{vj} = 150\,^{\circ}\text{C}$		1.56		
Gate threshold voltage	V_{GEth}	$I_C = 1\,\text{mA}$, $V_{CE} = V_{GE}$, $T_{vj} = 25\,^{\circ}\text{C}$		3.25	4.00	4.75	V
Gate charge	Q_G	$V_{GE} = \pm 15\,\text{V}$, $V_{CC} = 400\,\text{V}$, $T_{vj} = 25\,^{\circ}\text{C}$			0.42		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\,^{\circ}\text{C}$			0		Ω
Input capacitance	C_{ies}	$f = 100\,\text{kHz}$, $T_{vj} = 25\,^{\circ}\text{C}$, $V_{CE} = 25\,\text{V}$, $V_{GE} = 0\,\text{V}$			7.13		nF
Reverse transfer capacitance	C_{res}	$f = 100\,\text{kHz}$, $T_{vj} = 25\,^{\circ}\text{C}$, $V_{CE} = 25\,\text{V}$, $V_{GE} = 0\,\text{V}$			0.025		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 650\,\text{V}$, $V_{GE} = 0\,\text{V}$	$T_{vj} = 25\,^{\circ}\text{C}$			10	μA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\,\text{V}$, $V_{GE} = 20\,\text{V}$, $T_{vj} = 25\,^{\circ}\text{C}$				100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 100\,\text{A}$, $V_{CC} = 300\,\text{V}$, $V_{GE} = \pm 15\,\text{V}$, $R_{Gon} = 1\,\Omega$	$T_{vj} = 25\,^{\circ}\text{C}$		0.028		μs
			$T_{vj} = 125\,^{\circ}\text{C}$		0.028		
			$T_{vj} = 150\,^{\circ}\text{C}$		0.028		

(table continues...)

Table 6 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rise time (inductive load)	t_r	$I_C = 100 \text{ A}$, $V_{CC} = 300 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Gon} = 1 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$	0.017		μs
			$T_{vj} = 125 \text{ }^\circ\text{C}$	0.021		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	0.021		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 100 \text{ A}$, $V_{CC} = 300 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Goff} = 1 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$	0.070		μs
			$T_{vj} = 125 \text{ }^\circ\text{C}$	0.090		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	0.092		
Fall time (inductive load)	t_f	$I_C = 100 \text{ A}$, $V_{CC} = 300 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Goff} = 1 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$	0.036		μs
			$T_{vj} = 125 \text{ }^\circ\text{C}$	0.050		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	0.056		
Turn-on energy loss per pulse	E_{on}	$I_C = 100 \text{ A}$, $V_{CC} = 300 \text{ V}$, $L_\sigma = 23 \text{ nH}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Gon} = 1 \Omega$, $di/dt = 4300 \text{ A}/\mu\text{s}$ ($T_{vj} = 150 \text{ }^\circ\text{C}$)	$T_{vj} = 25 \text{ }^\circ\text{C}$	0.24		mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$	0.39		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	0.44		
Turn-off energy loss per pulse	E_{off}	$I_C = 100 \text{ A}$, $V_{CC} = 300 \text{ V}$, $L_\sigma = 23 \text{ nH}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Goff} = 1 \Omega$, $dv/dt = 6980 \text{ V}/\mu\text{s}$ ($T_{vj} = 150 \text{ }^\circ\text{C}$)	$T_{vj} = 25 \text{ }^\circ\text{C}$	1.1		mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$	1.58		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	1.74		
Thermal resistance, junction to heat sink	R_{thJH}	per IGBT, $\lambda_{grease} = 5 \text{ W}/(\text{m}\cdot\text{K})$		0.88		K/W
Temperature under switching conditions	$T_{vj op}$		-40		150	$^\circ\text{C}$

4 IGBT, T5 / T6

Table 7 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		$T_{vj} = 25 \text{ }^\circ\text{C}$	650	V
Implemented collector current	I_{CN}			100	A
Continuous DC collector current	I_{CDC}	$T_{vj max} = 175 \text{ }^\circ\text{C}$	$T_H = 65 \text{ }^\circ\text{C}$	75	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj op}$		200	A
Gate-emitter peak voltage	V_{GES}			± 20	V

Table 8 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 100\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$		1.42	1.90	V
			$T_{vj} = 125\ ^\circ C$		1.53		
			$T_{vj} = 150\ ^\circ C$		1.56		
Gate threshold voltage	V_{GETh}	$I_C = 1\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$		3.25	4.00	4.75	V
Gate charge	Q_G	$V_{GE} = \pm 15\ V, V_{CC} = 400\ V, T_{vj} = 25\ ^\circ C$			0.42		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\ ^\circ C$			0		Ω
Input capacitance	C_{ies}	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			7.13		nF
Reverse transfer capacitance	C_{res}	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			0.025		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 650\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$			29	μA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$				100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 100\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Gon} = 1\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.028		μs
			$T_{vj} = 125\ ^\circ C$		0.028		
			$T_{vj} = 150\ ^\circ C$		0.028		
Rise time (inductive load)	t_r	$I_C = 100\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Gon} = 1\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.017		μs
			$T_{vj} = 125\ ^\circ C$		0.021		
			$T_{vj} = 150\ ^\circ C$		0.021		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 100\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Goff} = 1\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.070		μs
			$T_{vj} = 125\ ^\circ C$		0.090		
			$T_{vj} = 150\ ^\circ C$		0.092		
Fall time (inductive load)	t_f	$I_C = 100\ A, V_{CC} = 300\ V, V_{GE} = \pm 15\ V, R_{Goff} = 1\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.036		μs
			$T_{vj} = 125\ ^\circ C$		0.050		
			$T_{vj} = 150\ ^\circ C$		0.056		
Turn-on energy loss per pulse	E_{on}	$I_C = 100\ A, V_{CC} = 300\ V, L_\sigma = 23\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 1\ \Omega, di/dt = 4300\ A/\mu s (T_{vj} = 150\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		0.24		mJ
			$T_{vj} = 125\ ^\circ C$		0.39		
			$T_{vj} = 150\ ^\circ C$		0.44		
Turn-off energy loss per pulse	E_{off}	$I_C = 100\ A, V_{CC} = 300\ V, L_\sigma = 23\ nH, V_{GE} = \pm 15\ V, R_{Goff} = 1\ \Omega, dv/dt = 6980\ V/\mu s (T_{vj} = 150\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		1.1		mJ
			$T_{vj} = 125\ ^\circ C$		1.58		
			$T_{vj} = 150\ ^\circ C$		1.74		
Thermal resistance, junction to heat sink	R_{thJH}	per IGBT, $\lambda_{grease} = 5\ W/(m \cdot K)$			0.74		K/W

(table continues...)

Table 8 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Temperature under switching conditions	$T_{vj\ op}$		-40		150	°C

5 Diode, D1 / D2 / D4

Table 9 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25\ ^\circ\text{C}$	650	V
Implemented forward current	I_{FN}			100	A
Continuous DC forward current	I_F			70	A
Repetitive peak forward current	I_{FRM}	$t_p = 1\ \text{ms}$		200	A
I^2t - value	I^2t	$t_p = 10\ \text{ms}, V_R = 0\ \text{V}$	$T_{vj} = 125\ ^\circ\text{C}$	455	A^2s
			$T_{vj} = 150\ ^\circ\text{C}$	520	

Table 10 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 100\ \text{A}, V_{GE} = 0\ \text{V}$	$T_{vj} = 25\ ^\circ\text{C}$	1.55	2.15	V
			$T_{vj} = 125\ ^\circ\text{C}$	1.50		
			$T_{vj} = 150\ ^\circ\text{C}$	1.45		
Peak reverse recovery current	I_{RM}	$V_{CC} = 300\ \text{V}, I_F = 100\ \text{A}, V_{GE} = -15\ \text{V}, -di_F/dt = 6750\ \text{A}/\mu\text{s} (T_{vj} = 150\ ^\circ\text{C})$	$T_{vj} = 25\ ^\circ\text{C}$	94		A
			$T_{vj} = 125\ ^\circ\text{C}$	126		
			$T_{vj} = 150\ ^\circ\text{C}$	137		
Recovered charge	Q_r	$V_{CC} = 300\ \text{V}, I_F = 100\ \text{A}, V_{GE} = -15\ \text{V}, -di_F/dt = 6750\ \text{A}/\mu\text{s} (T_{vj} = 150\ ^\circ\text{C})$	$T_{vj} = 25\ ^\circ\text{C}$	3.5		μC
			$T_{vj} = 125\ ^\circ\text{C}$	7.1		
			$T_{vj} = 150\ ^\circ\text{C}$	8.2		
Reverse recovery energy	E_{rec}	$V_{CC} = 300\ \text{V}, I_F = 100\ \text{A}, V_{GE} = -15\ \text{V}, -di_F/dt = 6750\ \text{A}/\mu\text{s} (T_{vj} = 150\ ^\circ\text{C})$	$T_{vj} = 25\ ^\circ\text{C}$	0.91		mJ
			$T_{vj} = 125\ ^\circ\text{C}$	1.9		
			$T_{vj} = 150\ ^\circ\text{C}$	2.24		
Thermal resistance, junction to heat sink	R_{thJH}	per diode, $\lambda_{grease} = 5\ \text{W}/(\text{m}\cdot\text{K})$		0.93		K/W

(table continues...)

Table 10 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Temperature under switching conditions	$T_{vj\,op}$		-40		150	°C

6 Diode, D5 / D6

Table 11 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25\,^{\circ}\text{C}$	650	V
Implemented forward current	I_{FN}			100	A
Continuous DC forward current	I_F			70	A
Repetitive peak forward current	I_{FRM}	$t_p = 1\,\text{ms}$		200	A
I^2t - value	I^2t	$t_p = 10\,\text{ms}, V_R = 0\,\text{V}$	$T_{vj} = 125\,^{\circ}\text{C}$	440	A^2s
			$T_{vj} = 150\,^{\circ}\text{C}$	500	

Table 12 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 100\,\text{A}, V_{GE} = 0\,\text{V}$	$T_{vj} = 25\,^{\circ}\text{C}$	1.65	2.15	V
			$T_{vj} = 125\,^{\circ}\text{C}$	1.55		
			$T_{vj} = 150\,^{\circ}\text{C}$	1.50		
Peak reverse recovery current	I_{RM}	$V_{CC} = 300\,\text{V}, I_F = 100\,\text{A}, V_{GE} = -15\,\text{V}, -di_F/dt = 4300\,\text{A}/\mu\text{s} (T_{vj} = 150\,^{\circ}\text{C})$	$T_{vj} = 25\,^{\circ}\text{C}$	70		A
			$T_{vj} = 125\,^{\circ}\text{C}$	95		
			$T_{vj} = 150\,^{\circ}\text{C}$	101		
Recovered charge	Q_r	$V_{CC} = 300\,\text{V}, I_F = 100\,\text{A}, V_{GE} = -15\,\text{V}, -di_F/dt = 4300\,\text{A}/\mu\text{s} (T_{vj} = 150\,^{\circ}\text{C})$	$T_{vj} = 25\,^{\circ}\text{C}$	2.5		μC
			$T_{vj} = 125\,^{\circ}\text{C}$	5.1		
			$T_{vj} = 150\,^{\circ}\text{C}$	6		
Reverse recovery energy	E_{rec}	$V_{CC} = 300\,\text{V}, I_F = 100\,\text{A}, V_{GE} = -15\,\text{V}, -di_F/dt = 4300\,\text{A}/\mu\text{s} (T_{vj} = 150\,^{\circ}\text{C})$	$T_{vj} = 25\,^{\circ}\text{C}$	0.62		mJ
			$T_{vj} = 125\,^{\circ}\text{C}$	1.21		
			$T_{vj} = 150\,^{\circ}\text{C}$	1.41		
Thermal resistance, junction to heat sink	R_{thJH}	per diode, $\lambda_{grease} = 5\,\text{W}/(\text{m}\cdot\text{K})$		0.80		K/W

(table continues...)

Table 12 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Temperature under switching conditions	$T_{vj\,op}$		-40		150	°C

7 NTC-Thermistor

Table 13 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25\text{ °C}$		5		kΩ
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100\text{ °C}$, $R_{100} = 493\text{ Ω}$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25\text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$		3433		K

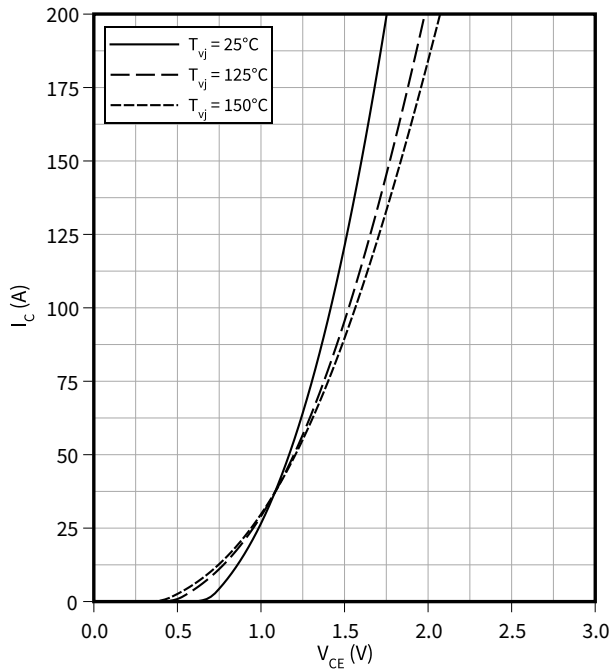
Note: For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4

8 Characteristics diagrams

Output characteristic (typical), IGBT, T1 / T3

$I_C = f(V_{CE})$

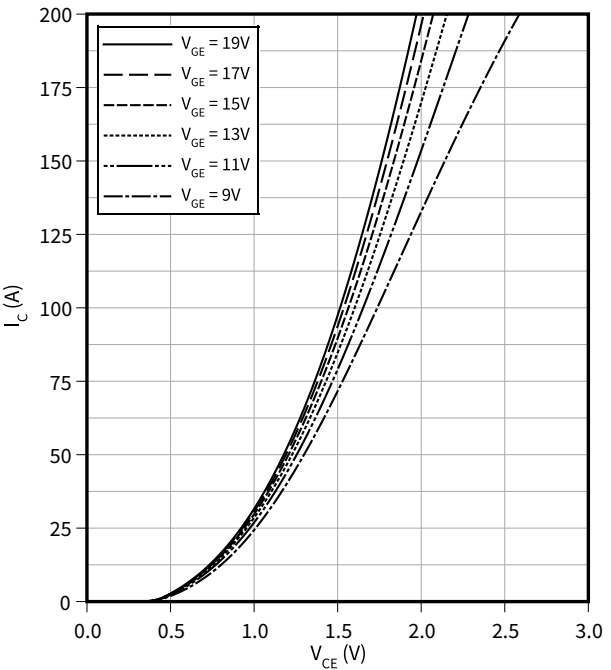
$V_{GE} = 15\text{ V}$



Output characteristic field (typical), IGBT, T1 / T3

$I_C = f(V_{CE})$

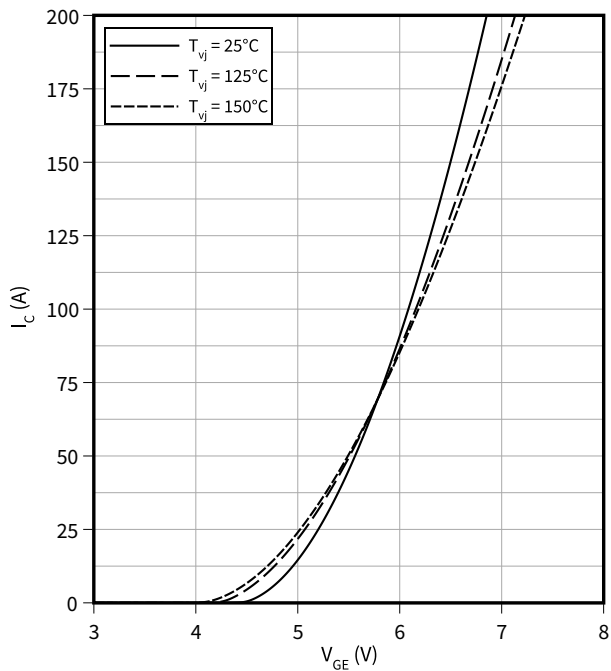
$T_{vj} = 150^\circ\text{C}$



Transfer characteristic (typical), IGBT, T1 / T3

$I_C = f(V_{GE})$

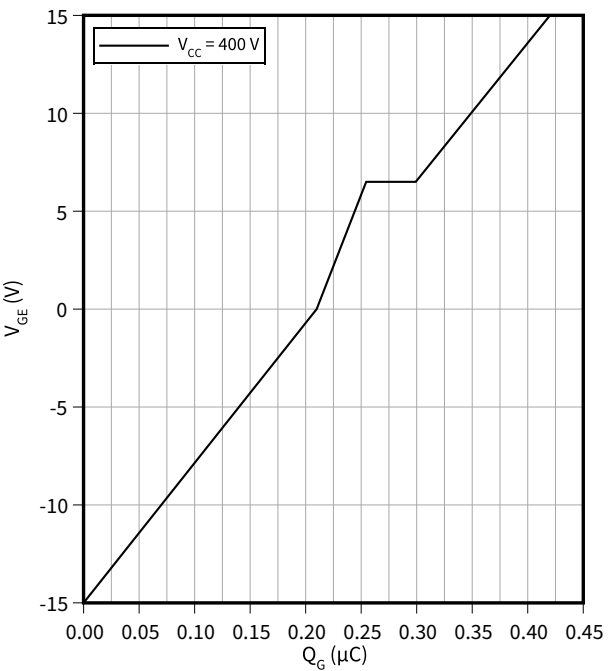
$V_{CE} = 20\text{ V}$



Gate charge characteristic (typical), IGBT, T1 / T3

$V_{GE} = f(Q_G)$

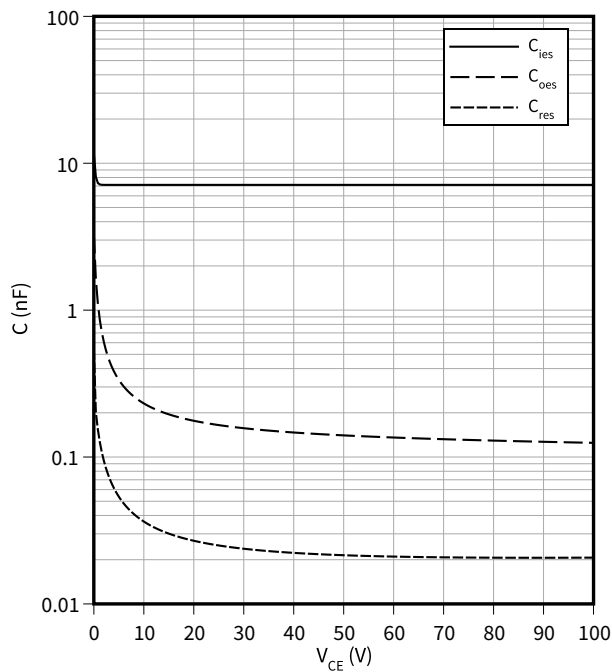
$I_C = 100\text{ A}, T_{vj} = 25^\circ\text{C}$



8 Characteristics diagrams

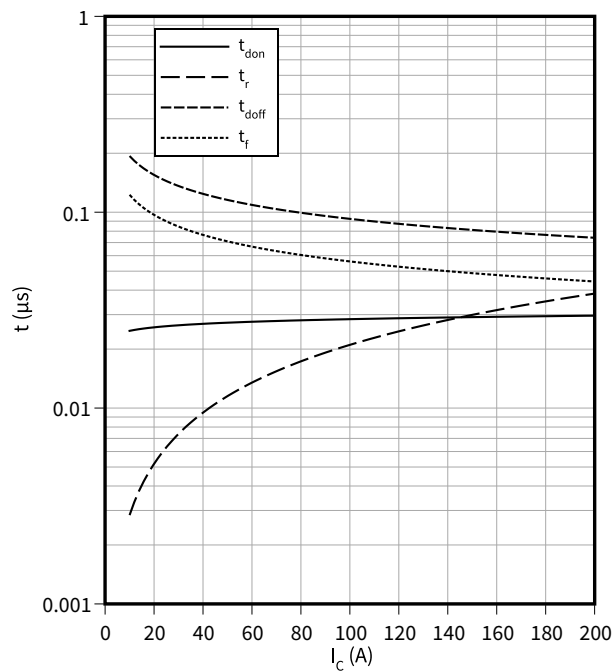
Capacity characteristic (typical), IGBT, T1 / T3

$C = f(V_{CE})$
 $f = 100 \text{ kHz}$, $V_{GE} = 0 \text{ V}$, $T_{vj} = 25 \text{ }^{\circ}\text{C}$



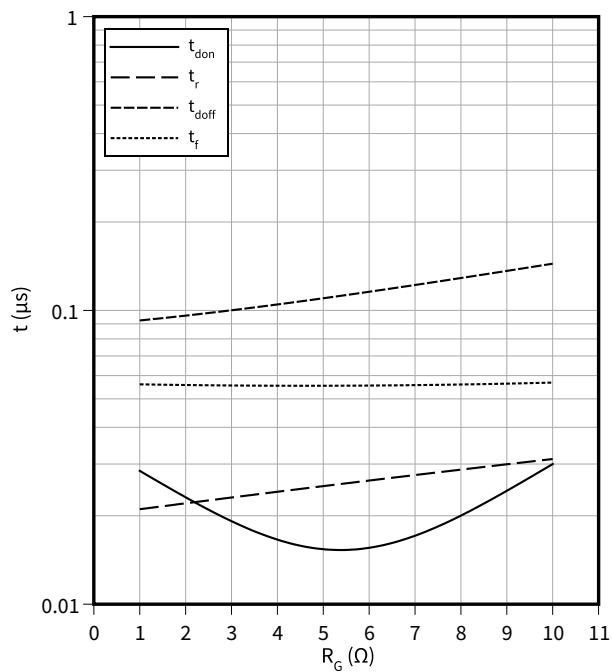
Switching times (typical), IGBT, T1 / T3

$t = f(I_C)$
 $R_{Goff} = 1 \text{ } \Omega$, $R_{Gon} = 1 \text{ } \Omega$, $V_{GE} = \pm 15 \text{ V}$, $V_{CC} = 300 \text{ V}$, $T_{vj} = 150 \text{ }^{\circ}\text{C}$



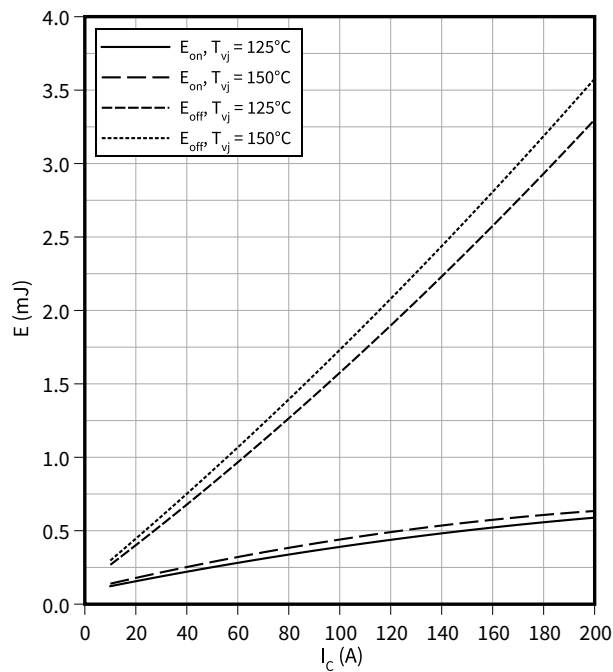
Switching times (typical), IGBT, T1 / T3

$t = f(R_G)$
 $V_{GE} = \pm 15 \text{ V}$, $I_C = 100 \text{ A}$, $V_{CC} = 300 \text{ V}$, $T_{vj} = 150 \text{ }^{\circ}\text{C}$



Switching losses (typical), IGBT, T1 / T3

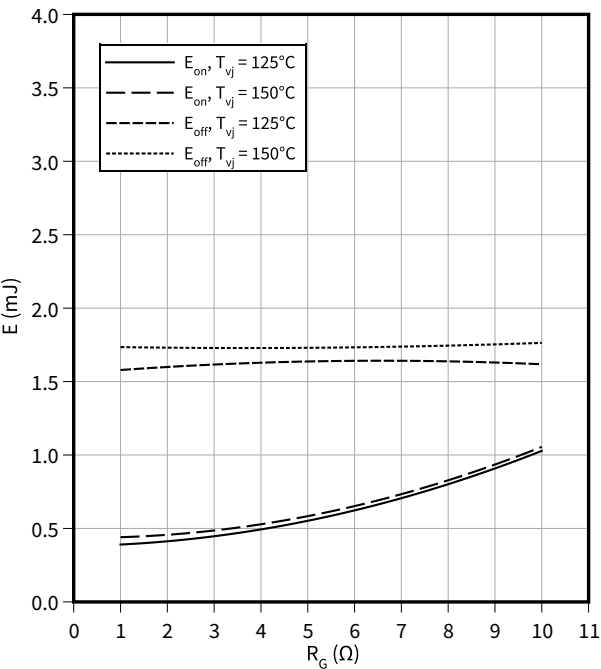
$E = f(I_C)$
 $R_{Goff} = 1 \text{ } \Omega$, $R_{Gon} = 1 \text{ } \Omega$, $V_{GE} = \pm 15 \text{ V}$, $V_{CC} = 300 \text{ V}$



8 Characteristics diagrams

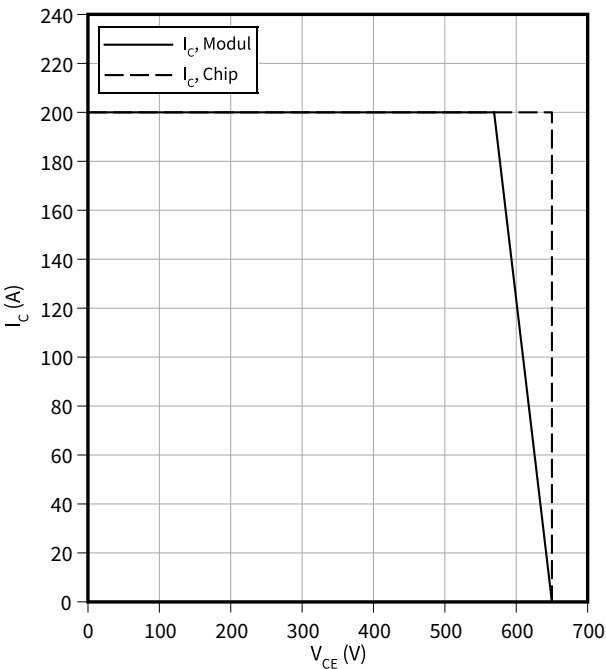
Switching losses (typical), IGBT, T1 / T3

$E = f(R_G)$
 $V_{GE} = \pm 15\text{ V}$, $I_C = 100\text{ A}$, $V_{CC} = 300\text{ V}$



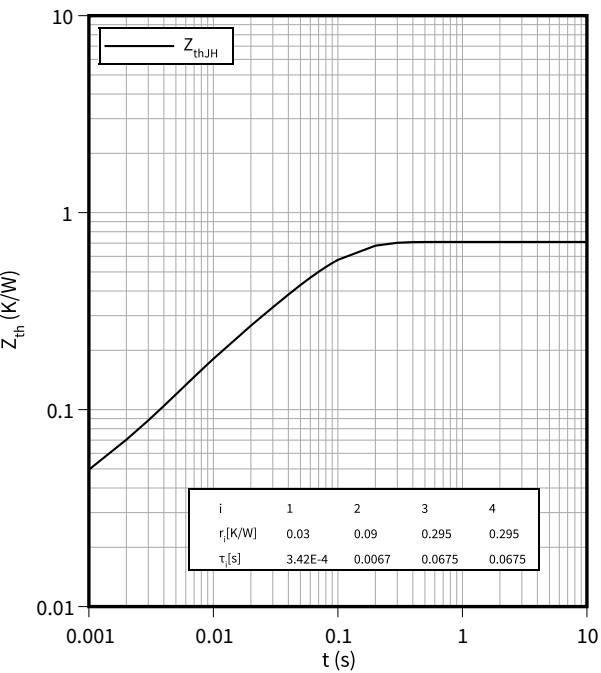
Reverse bias safe operating area (RBSOA), IGBT, T1 / T3

$I_C = f(V_{CE})$
 $R_{Goff} = 1\text{ }\Omega$, $V_{GE} = \pm 15\text{ V}$, $T_{vj} = 150\text{ }^\circ\text{C}$



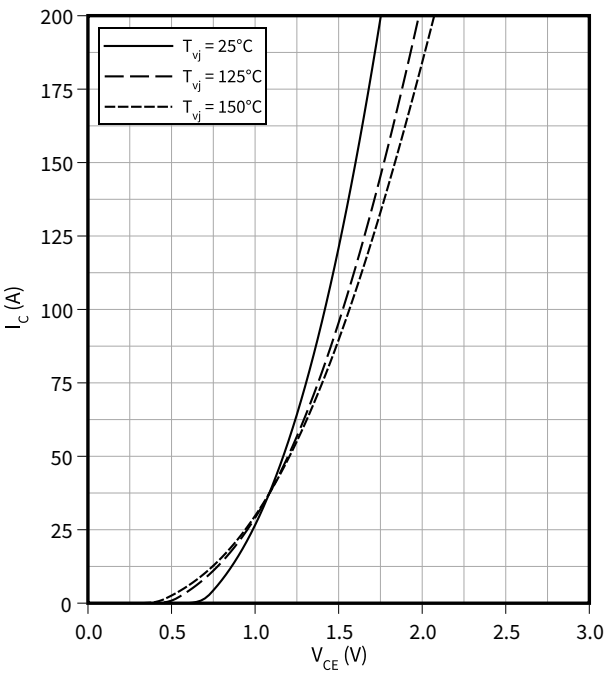
Transient thermal impedance, IGBT, T1 / T3

$Z_{th} = f(t)$



Output characteristic (typical), IGBT, T2 / T4

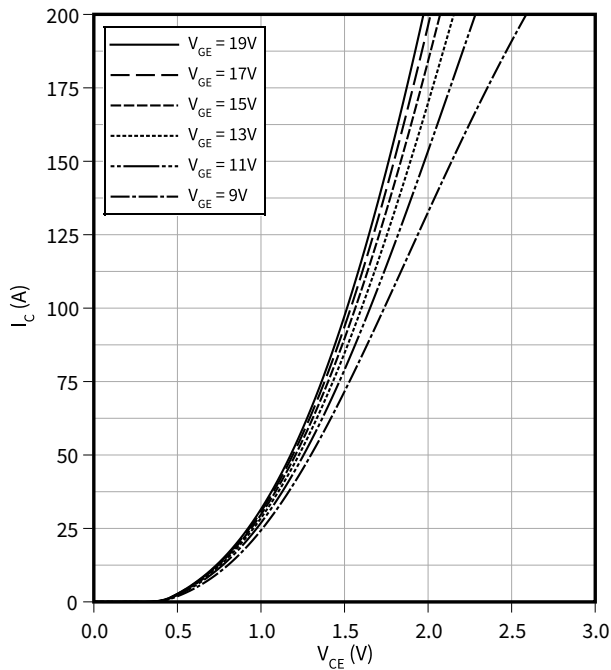
$I_C = f(V_{CE})$
 $V_{GE} = 15\text{ V}$



8 Characteristics diagrams

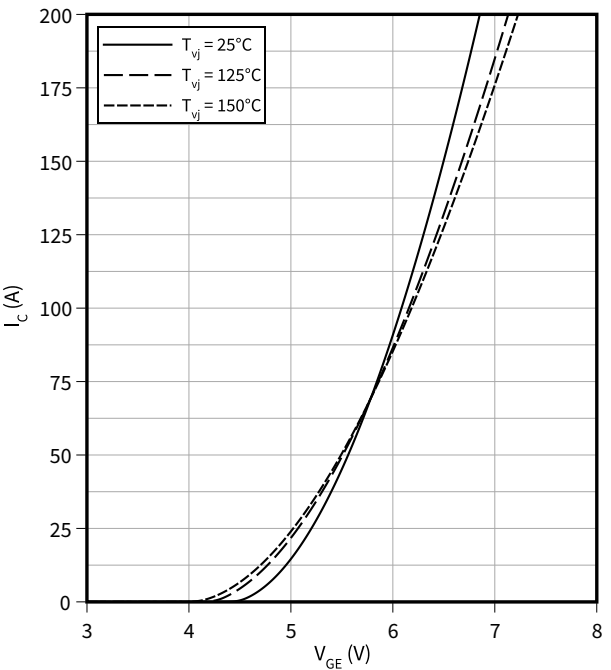
Output characteristic field (typical), IGBT, T2 / T4

$I_C = f(V_{CE})$
 $T_{vj} = 150\text{ °C}$



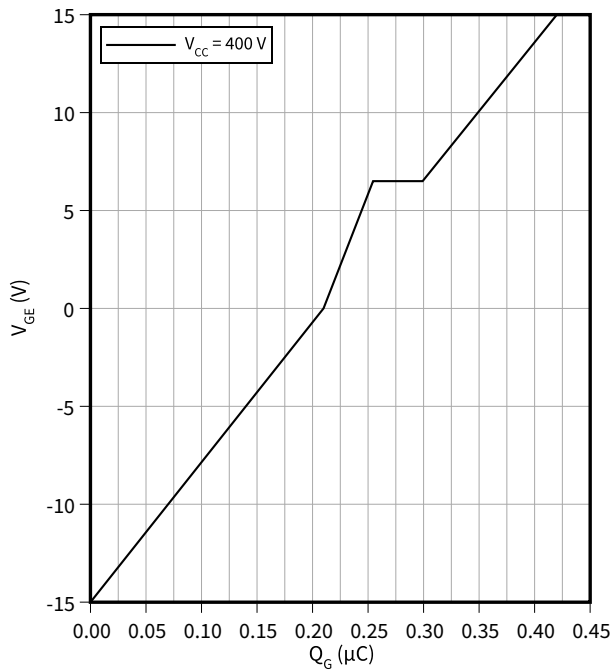
Transfer characteristic (typical), IGBT, T2 / T4

$I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



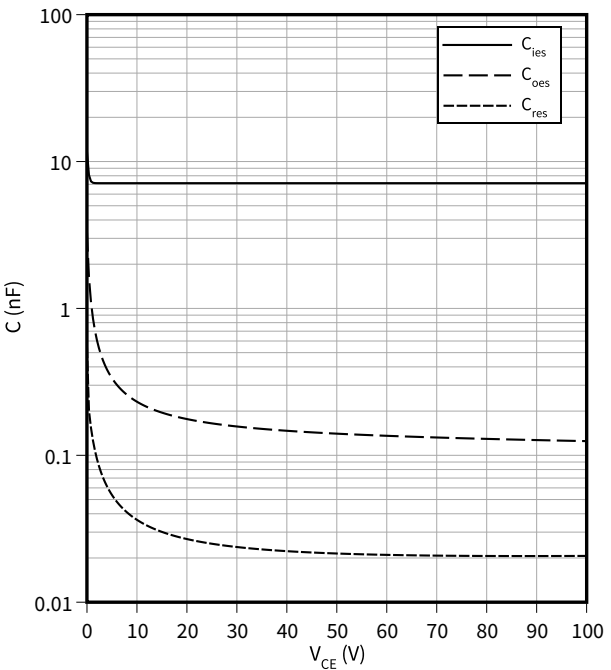
Gate charge characteristic (typical), IGBT, T2 / T4

$V_{GE} = f(Q_G)$
 $I_C = 100\text{ A}$, $T_{vj} = 25\text{ °C}$



Capacity characteristic (typical), IGBT, T2 / T4

$C = f(V_{CE})$
 $f = 100\text{ kHz}$, $V_{GE} = 0\text{ V}$, $T_{vj} = 25\text{ °C}$

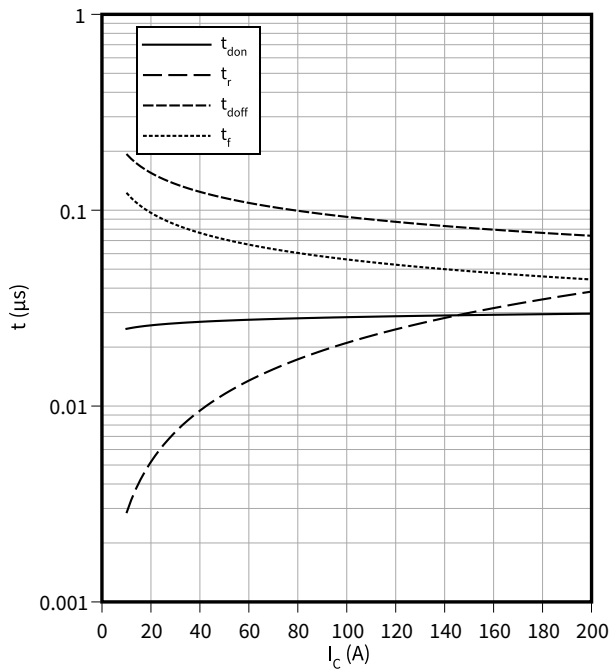


8 Characteristics diagrams

Switching times (typical), IGBT, T2 / T4

$t = f(I_C)$

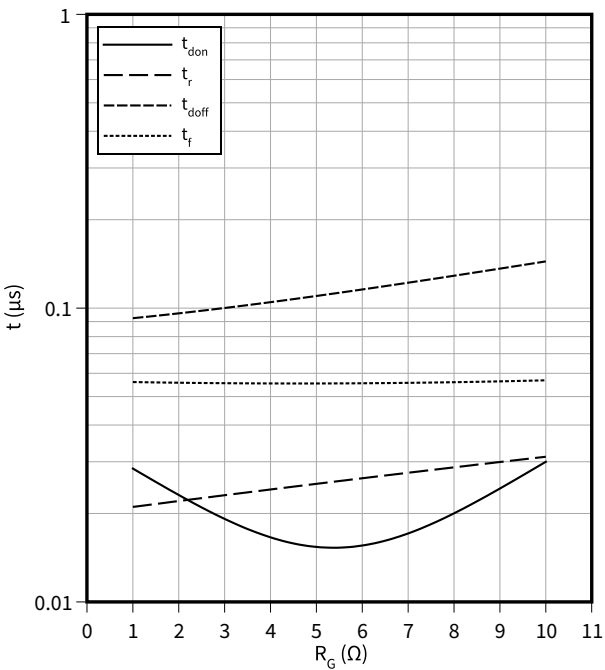
$R_{Goff} = 1 \Omega$, $R_{Gon} = 1 \Omega$, $V_{GE} = \pm 15 \text{ V}$, $V_{CC} = 300 \text{ V}$, $T_{vj} = 150^\circ \text{ C}$



Switching times (typical), IGBT, T2 / T4

$t = f(R_G)$

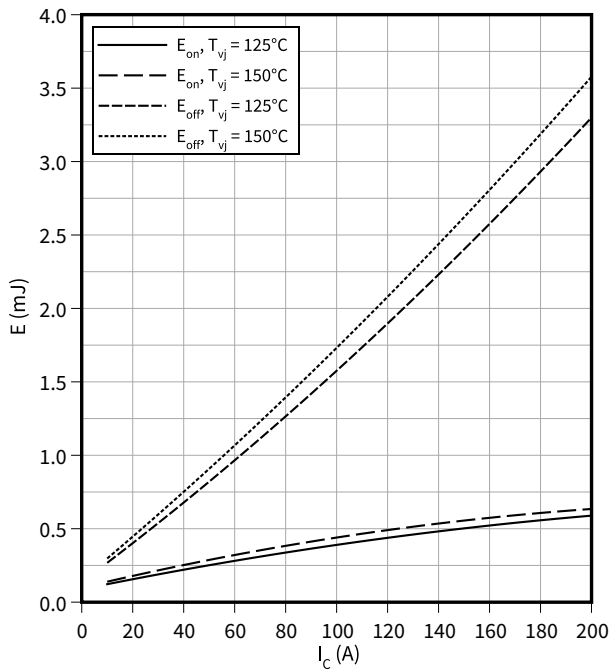
$V_{GE} = \pm 15 \text{ V}$, $I_C = 100 \text{ A}$, $V_{CC} = 300 \text{ V}$, $T_{vj} = 150^\circ \text{ C}$



Switching losses (typical), IGBT, T2 / T4

$E = f(I_C)$

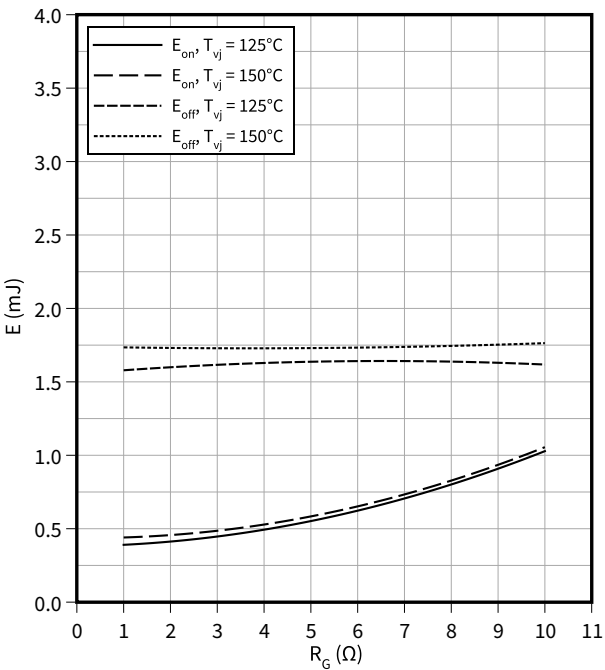
$R_{Goff} = 1 \Omega$, $R_{Gon} = 1 \Omega$, $V_{GE} = \pm 15 \text{ V}$, $V_{CC} = 300 \text{ V}$



Switching losses (typical), IGBT, T2 / T4

$E = f(R_G)$

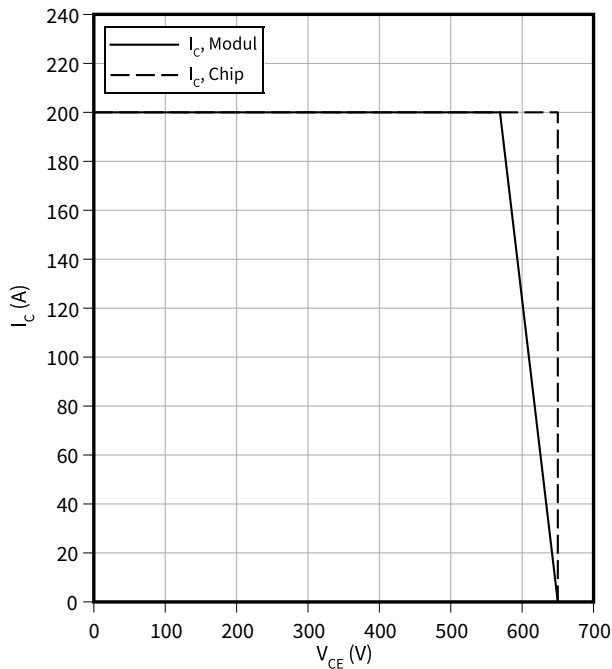
$V_{GE} = \pm 15 \text{ V}$, $I_C = 100 \text{ A}$, $V_{CC} = 300 \text{ V}$



8 Characteristics diagrams

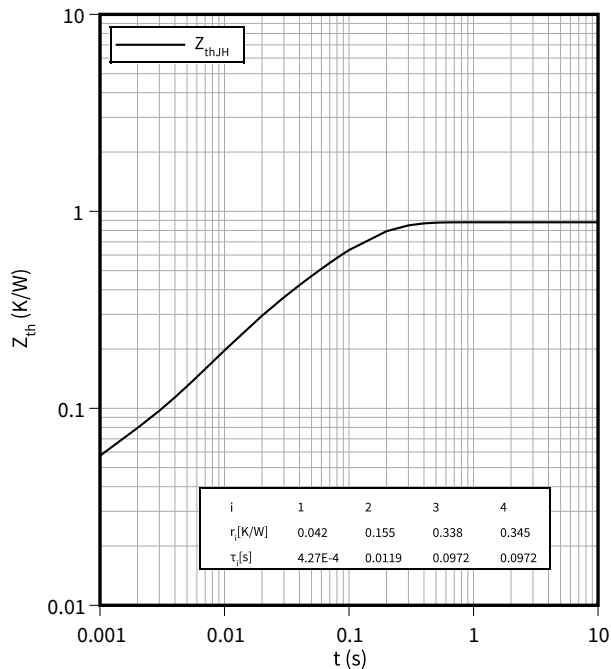
Reverse bias safe operating area (RBSOA), IGBT, T2 / T4

$I_C = f(V_{CE})$
 $R_{Goff} = 1\ \Omega$, $V_{GE} = \pm 15\ V$, $T_{vj} = 150\ ^\circ C$



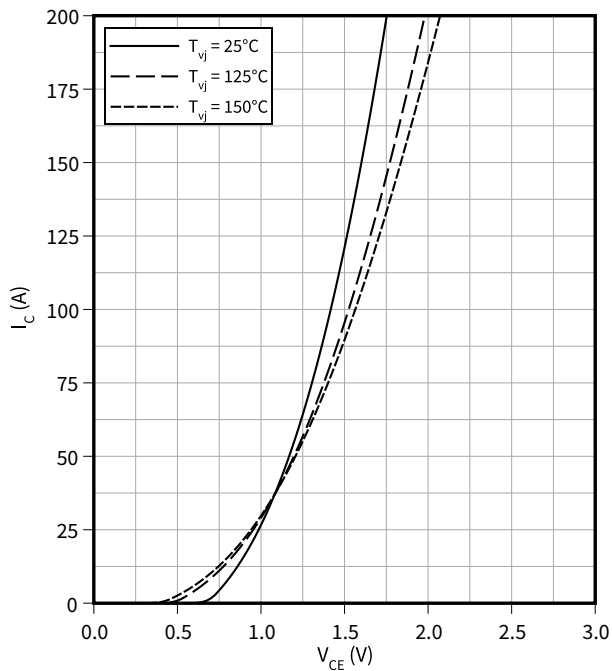
Transient thermal impedance, IGBT, T2 / T4

$Z_{th} = f(t)$



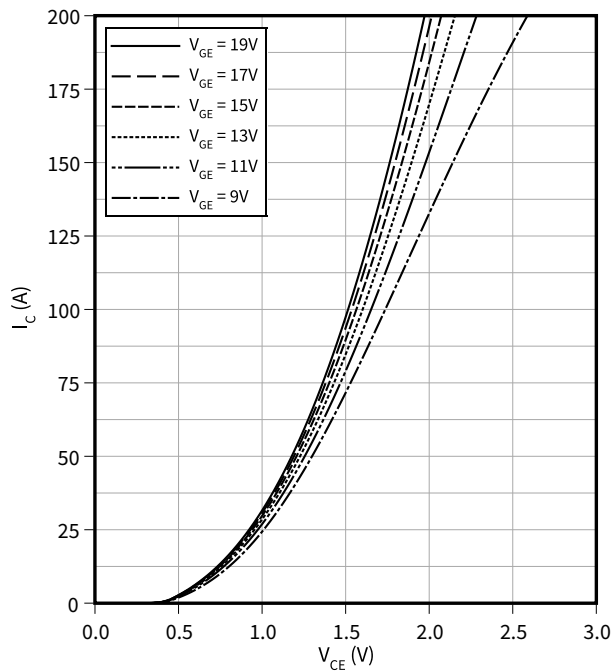
Output characteristic (typical), IGBT, T5 / T6

$I_C = f(V_{CE})$
 $V_{GE} = 15\ V$



Output characteristic field (typical), IGBT, T5 / T6

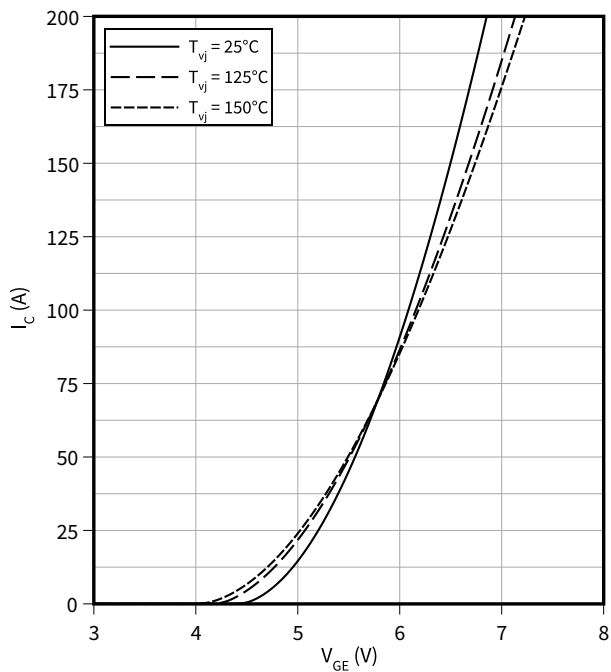
$I_C = f(V_{CE})$
 $T_{vj} = 150\ ^\circ C$



8 Characteristics diagrams

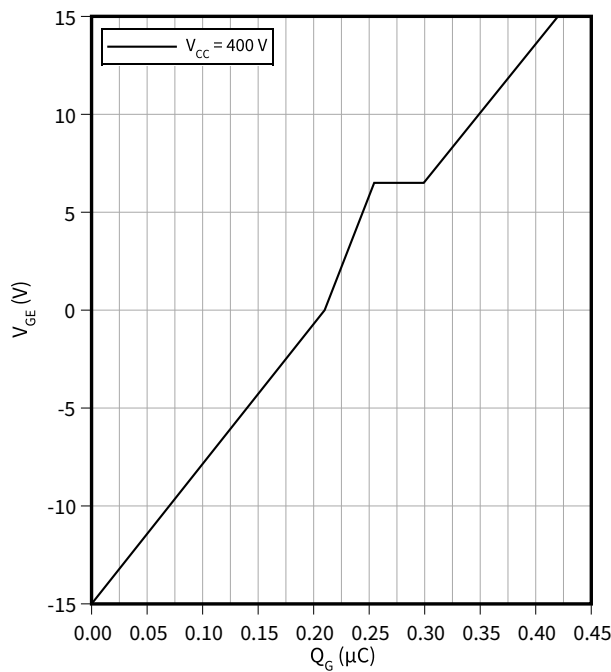
Transfer characteristic (typical), IGBT, T5 / T6

$I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



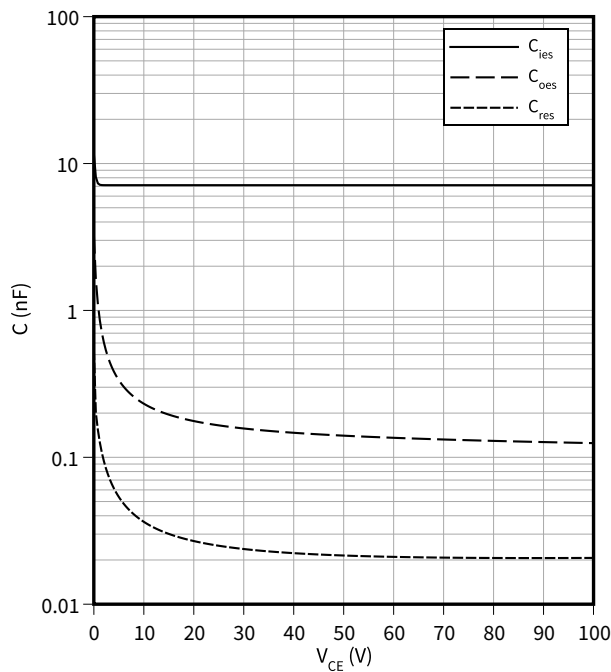
Gate charge characteristic (typical), IGBT, T5 / T6

$V_{GE} = f(Q_G)$
 $I_C = 100\text{ A}$, $T_{vj} = 25\text{ °C}$



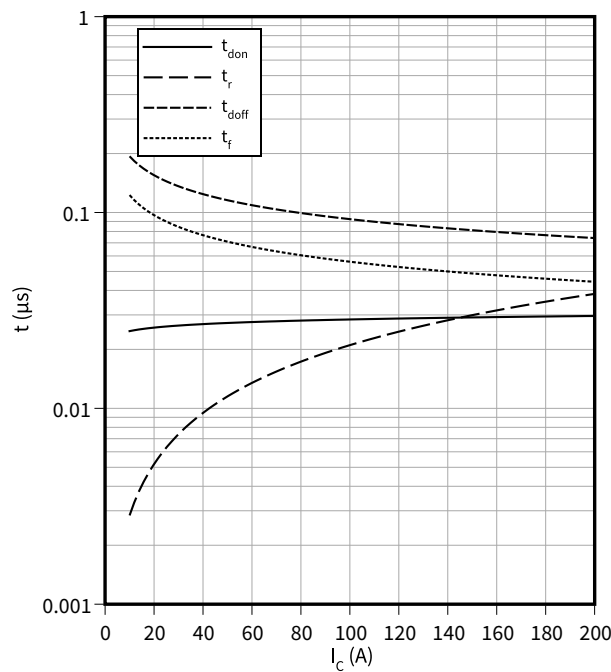
Capacity characteristic (typical), IGBT, T5 / T6

$C = f(V_{CE})$
 $V_{GE} = 0\text{ V}$, $T_{vj} = 25\text{ °C}$, $f = 100\text{ kHz}$



Switching times (typical), IGBT, T5 / T6

$t = f(I_C)$
 $R_{Goff} = 1\text{ }\Omega$, $R_{Gon} = 1\text{ }\Omega$, $V_{GE} = \pm 15\text{ V}$, $V_{CC} = 300\text{ V}$, $T_{vj} = 150\text{ °C}$

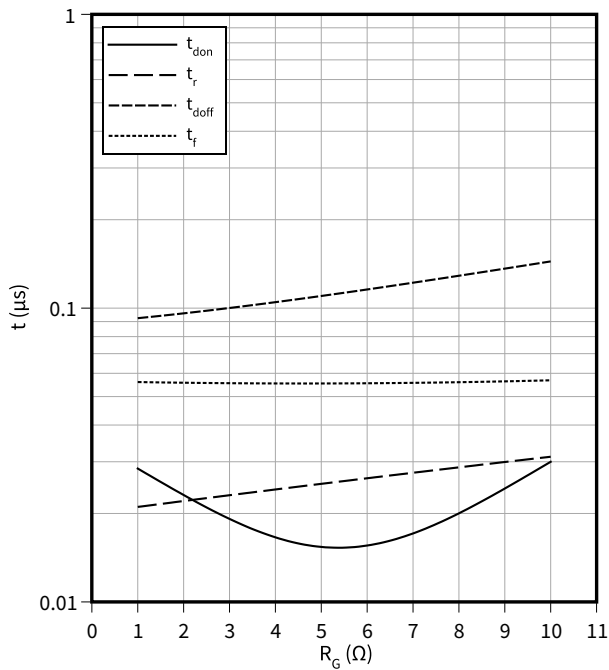


8 Characteristics diagrams

Switching times (typical), IGBT, T5 / T6

$t = f(R_G)$

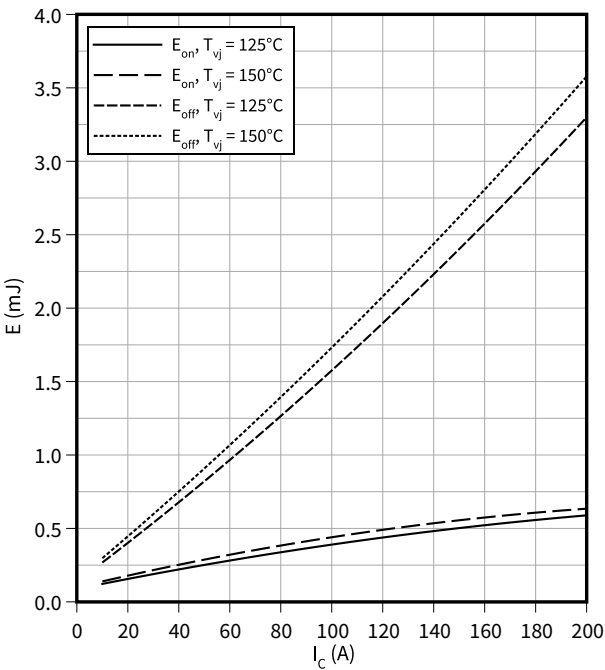
$V_{GE} = \pm 15\text{ V}$, $I_C = 100\text{ A}$, $V_{CC} = 300\text{ V}$, $T_{vj} = 150\text{ }^\circ\text{C}$



Switching losses (typical), IGBT, T5 / T6

$E = f(I_C)$

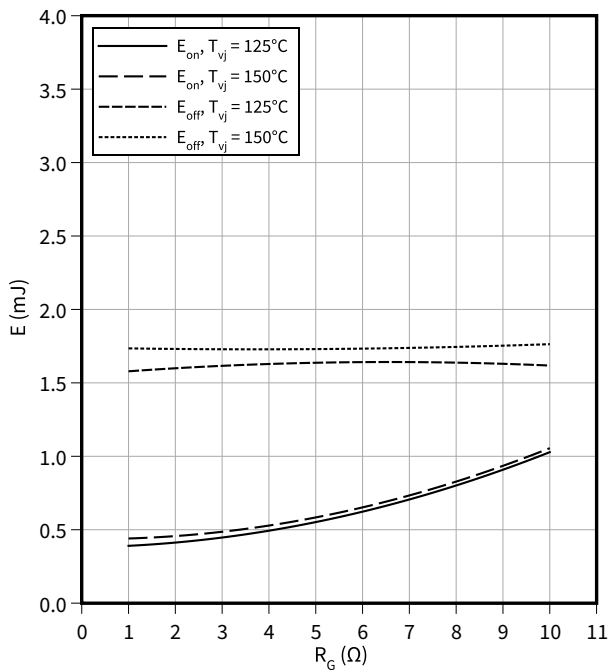
$V_{CC} = 300\text{ V}$, $R_{Goff} = 1\text{ } \Omega$, $R_{Gon} = 1\text{ } \Omega$, $V_{GE} = \pm 15\text{ V}$



Switching losses (typical), IGBT, T5 / T6

$E = f(R_G)$

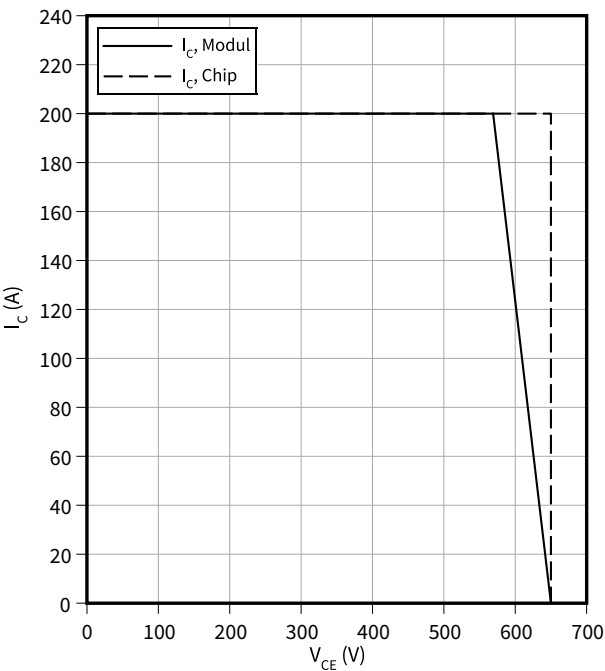
$V_{GE} = \pm 15\text{ V}$, $I_C = 100\text{ A}$, $V_{CC} = 300\text{ V}$



Reverse bias safe operating area (RBSOA), IGBT, T5 / T6

$I_C = f(V_{CE})$

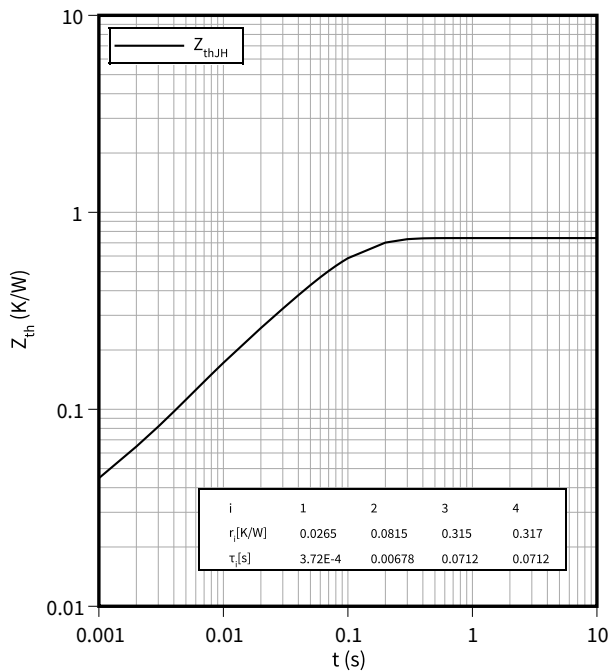
$T_{vj} = 150\text{ }^\circ\text{C}$, $R_{Goff} = 1\text{ } \Omega$, $V_{GE} = \pm 15\text{ V}$



8 Characteristics diagrams

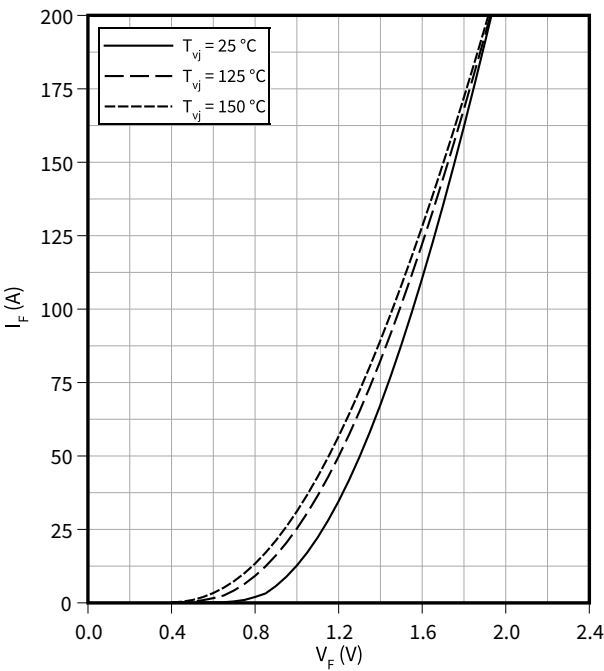
Transient thermal impedance, IGBT, T5 / T6

$Z_{th} = f(t)$



Forward characteristic (typical), Diode, D1 / D2 / D4

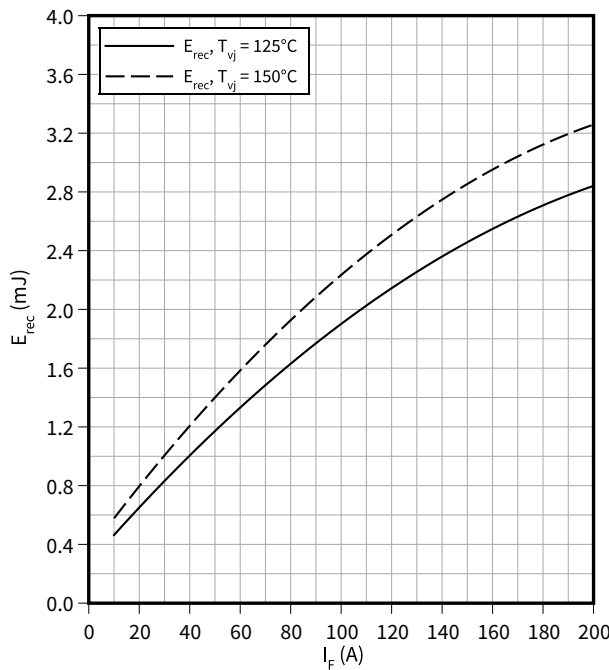
$I_F = f(V_F)$



Switching losses (typical), Diode, D1 / D2 / D4

$E_{rec} = f(I_F)$

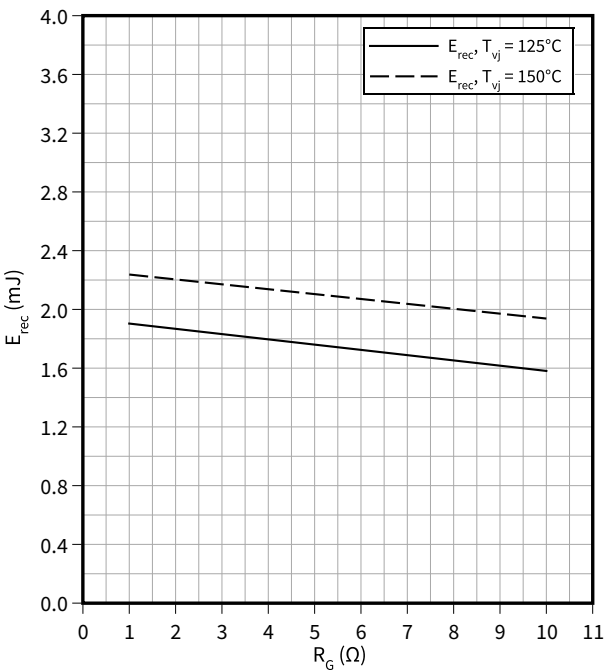
$R_{Gon} = 1 \Omega, V_{CE} = 300 V$



Switching losses (typical), Diode, D1 / D2 / D4

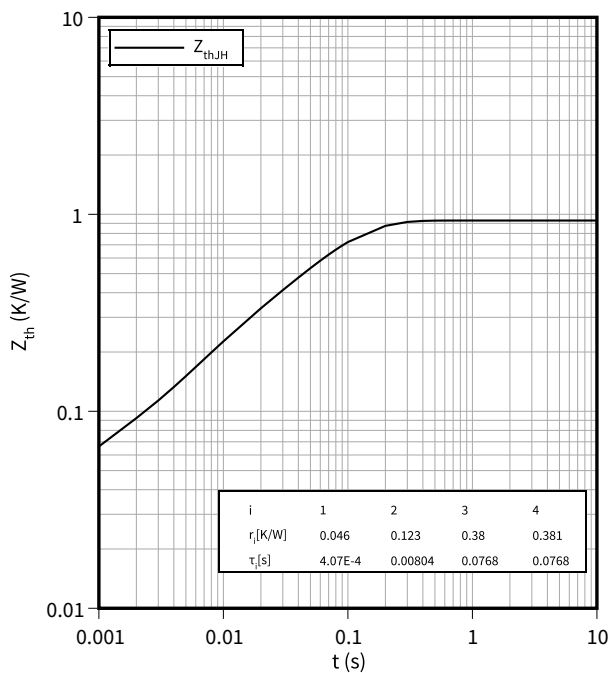
$E_{rec} = f(R_G)$

$V_{CE} = 300 V, I_F = 100 A$



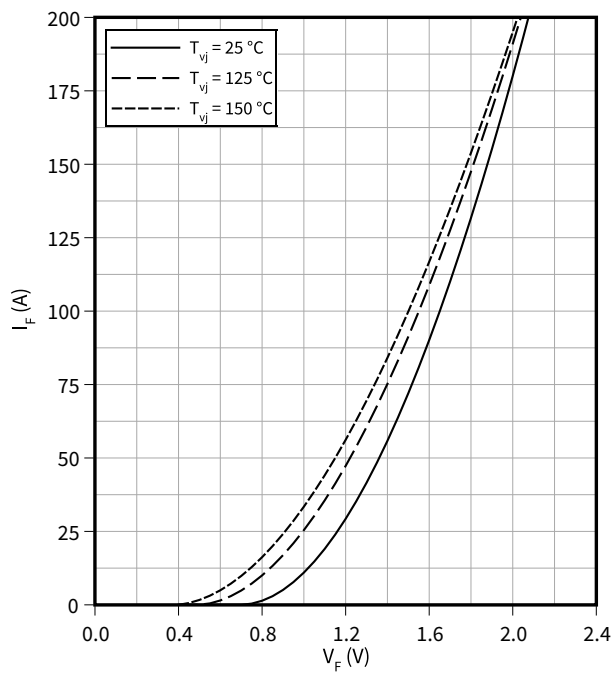
Transient thermal impedance, Diode, D1 / D2 / D4

$Z_{th} = f(t)$



Forward characteristic (typical), Diode, D5 / D6

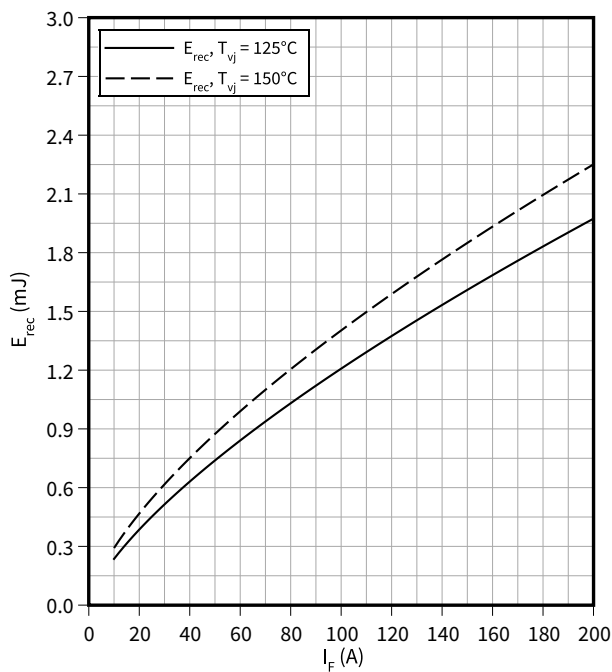
$I_F = f(V_F)$



Switching losses (typical), Diode, D5 / D6

$E_{rec} = f(I_F)$

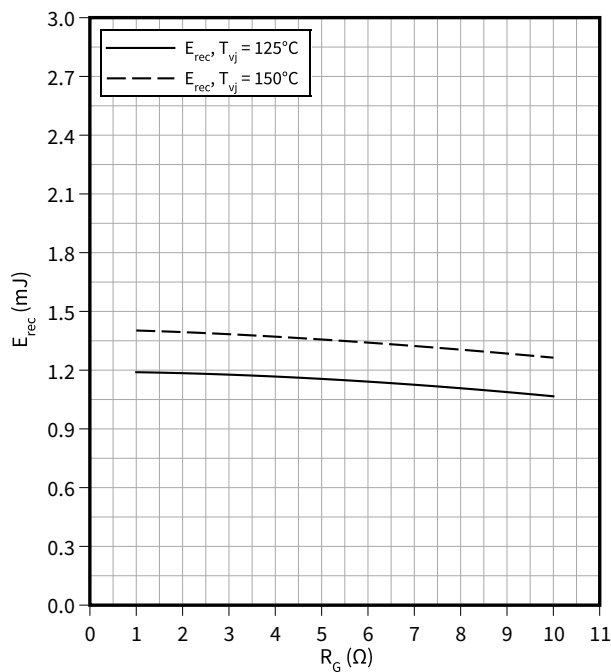
$R_{Gon} = 1 \Omega, V_{CE} = 300 V$



Switching losses (typical), Diode, D5 / D6

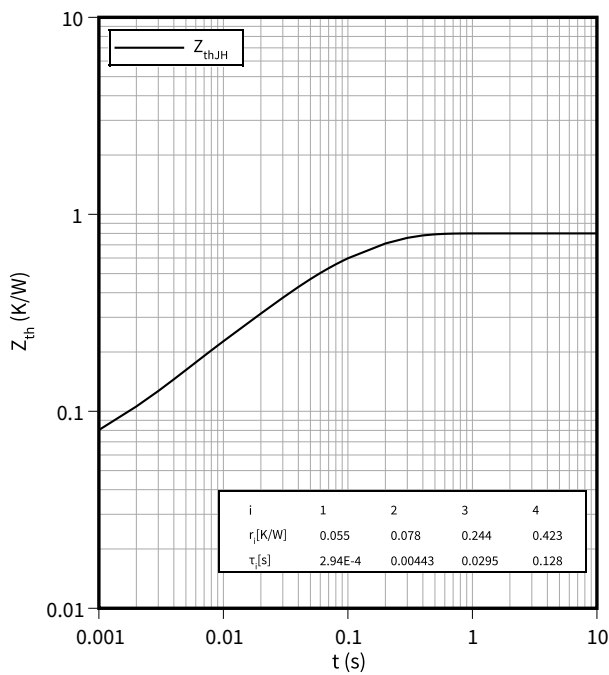
$E_{rec} = f(R_G)$

$V_{CE} = 300 V, I_F = 100 A$



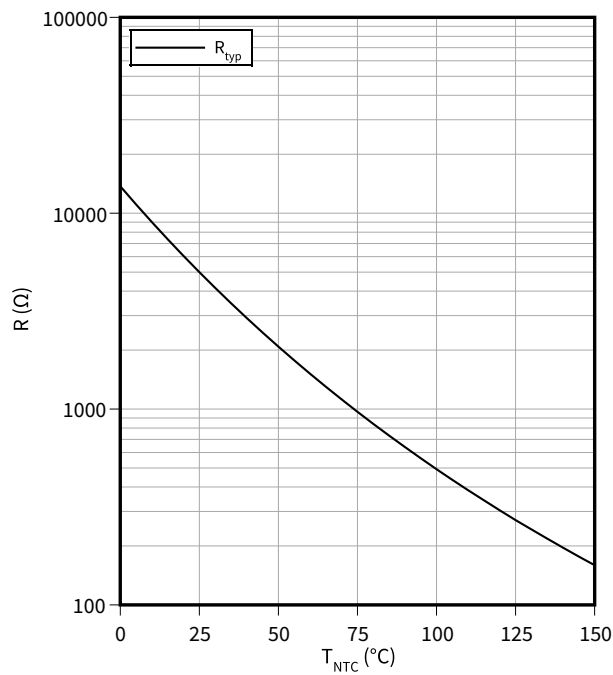
Transient thermal impedance, Diode, D5 / D6

$Z_{th} = f(t)$



Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



9 Circuit diagram

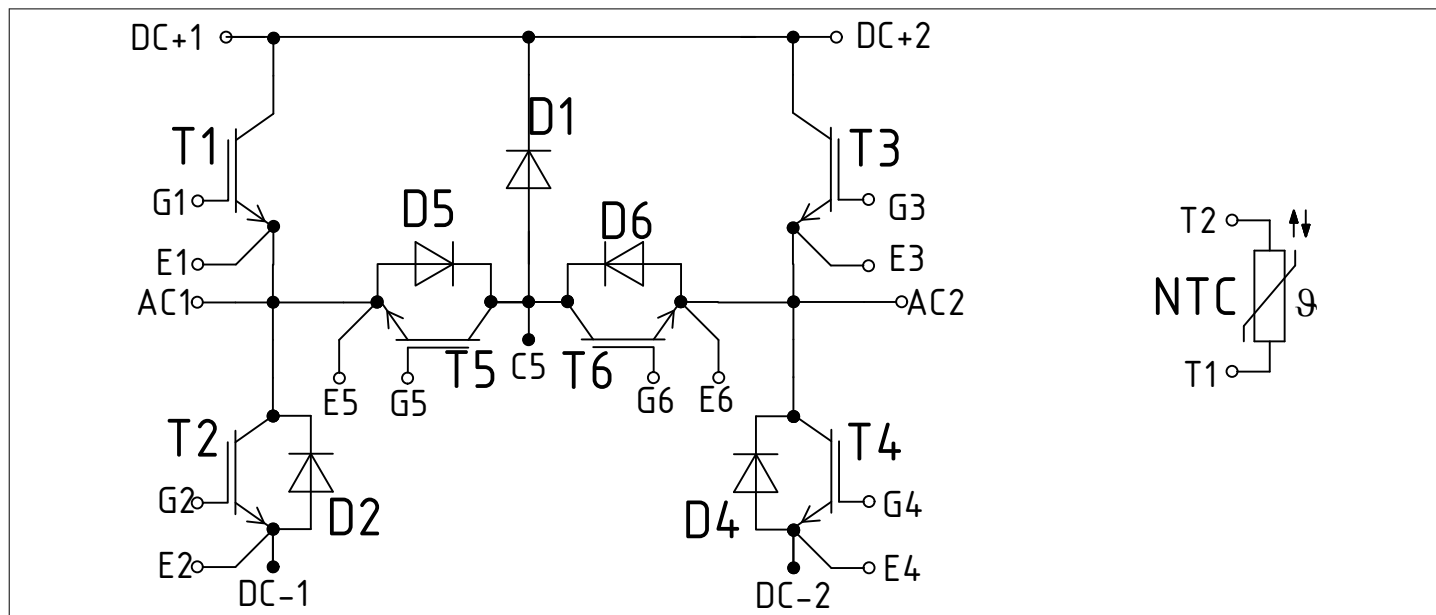


Figure 1

10 Package outlines

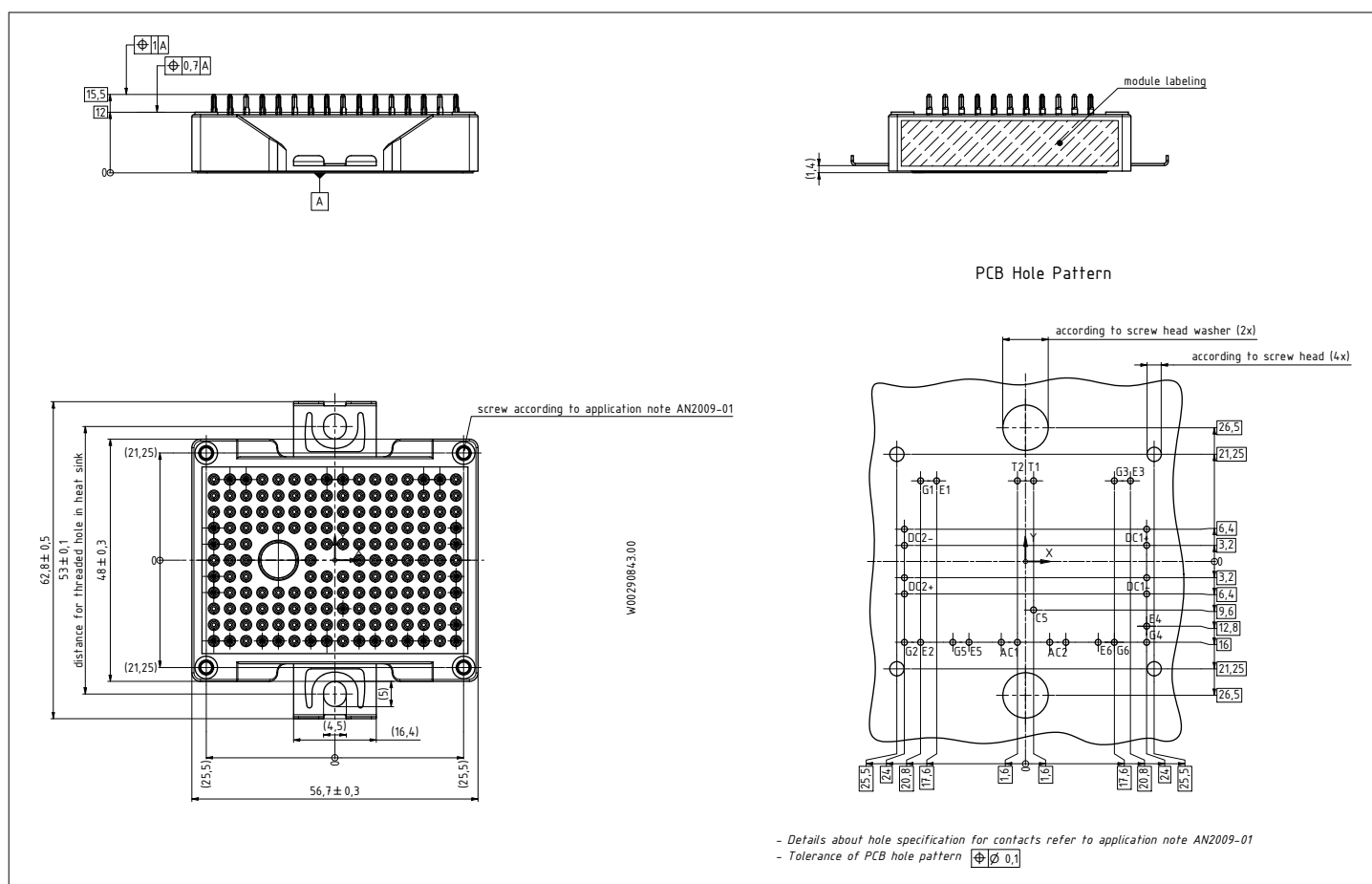


Figure 2

11 Module label code

Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	<i>Content</i>	<i>Digit</i>	<i>Example</i>
	Module serial number	1 – 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 – 21	15
	Date code (production week)	22 – 23	30
Example			
			
71549142846550549911530		71549142846550549911530	

Figure 3



Revision history

Revision history

Document version	Date of release	Description of changes
0.10	2025-06-17	Target datasheet
1.00	2025-11-07	Final datasheet
1.10	2025-11-13	Final datasheet

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Edition 2025-11-13

Published by

Infineon Technologies AG
81726 Munich, Germany

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Document reference
IFX-ABO644-003

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